
2SC2736

Silicon NPN Epitaxial

HITACHI

ADE-208-1076 (Z)

1st. Edition

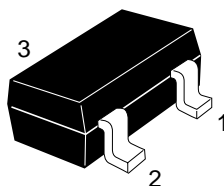
Mar. 2001

Application

- UHF/VHF frequency converter
- Local oscillator

Outline

MPAK



- 1. Emitter
- 2. Base
- 3. Collector

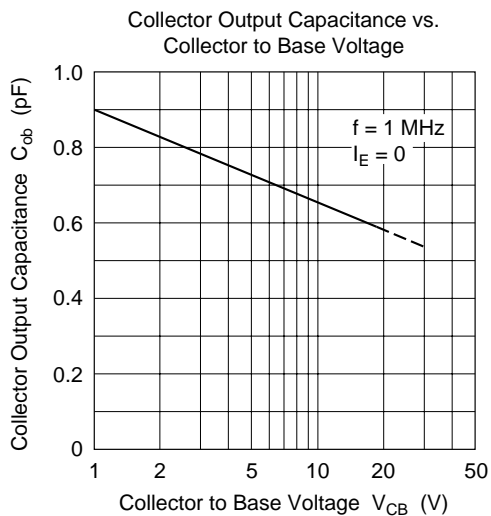
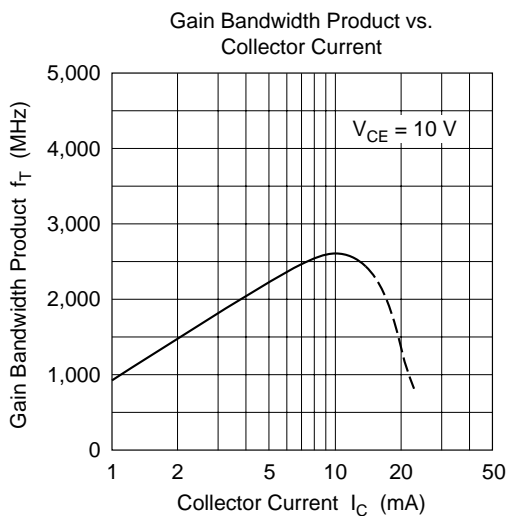
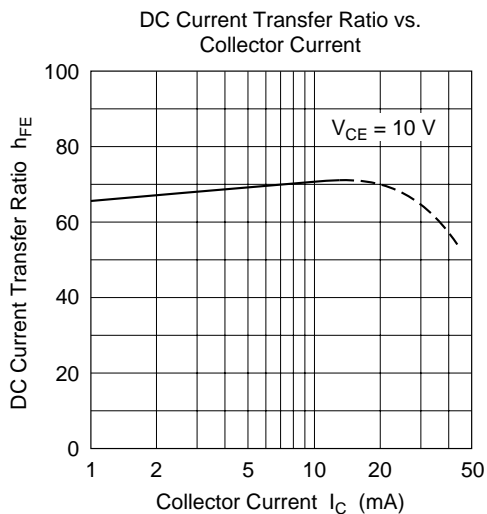
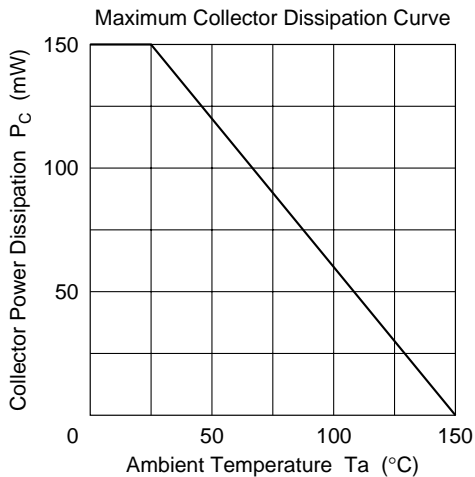
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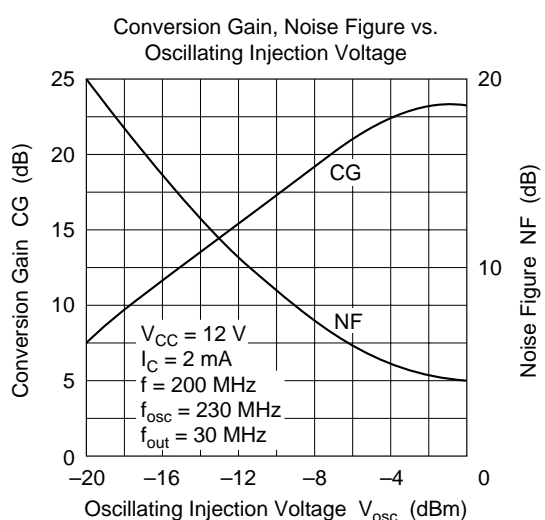
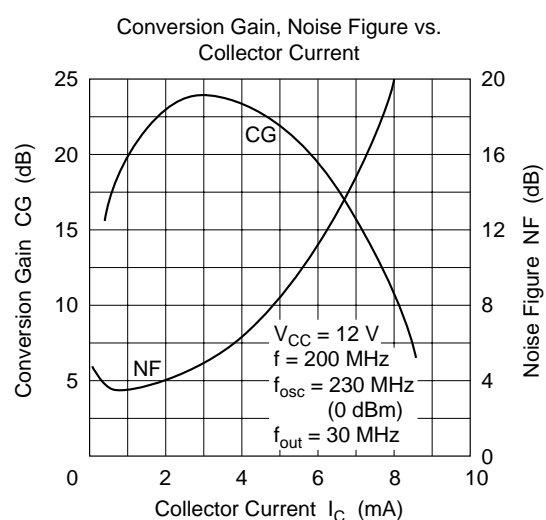
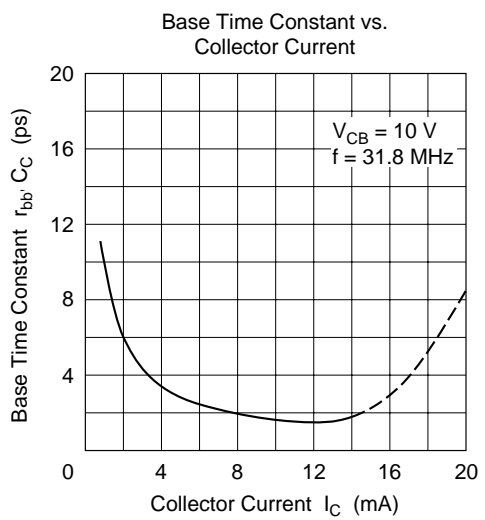
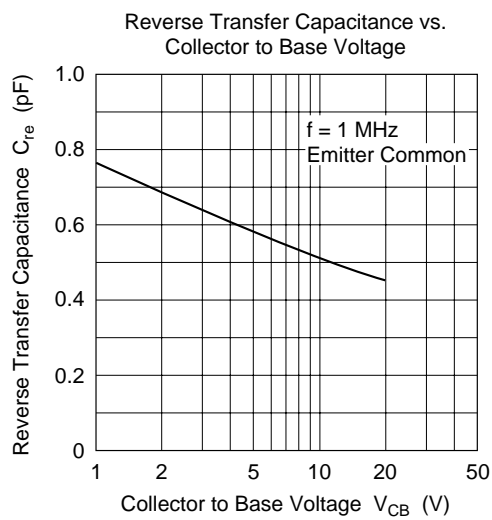
Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	30	V
Collector to emitter voltage	V_{CEO}	20	V
Emitter to base voltage	V_{EBO}	3	V
Collector current	I_C	50	mA
Collector power dissipation	P_C	150	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	–55 to +150	°C

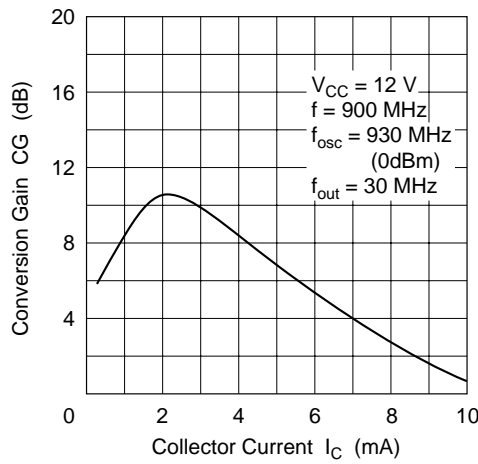
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	30	—	—	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	20	—	—	V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	3	—	—	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I_{CBO}	—	—	500	nA	$V_{CB} = 15 \text{ V}, I_C = 0$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	0.7	V	$I_C = 10 \text{ mA}, I_B = 5 \text{ mA}$
DC current transfer ratio	h_{FE}	30	—	200		$V_{CE} = 10 \text{ V}, I_C = 5 \text{ mA}$
Collector output capacitance	C_{ob}	—	—	1.0	pF	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$
Gain bandwidth product	f_T	1400	2200	—	MHz	$V_{CE} = 10 \text{ V}, I_C = 5 \text{ mA}$
Conversion gain	CG_1	—	22.5	—	dB	$V_{CC} = 12 \text{ V}, I_C = 2 \text{ mA},$ $f = 200 \text{ MHz},$ $f_{OSC} = 230 \text{ MHz (0dBm)}$
	CG_2	—	10	—	dB	$V_{CC} = 12 \text{ V}, I_C = 2 \text{ mA},$ $f = 900 \text{ MHz},$ $f_{OSC} = 930 \text{ MHz (0dBm)},$ $f_{Out} = 30 \text{ MHz}$
Noise figure	NF	—	4.0	—	dB	$V_{CC} = 12 \text{ V}, I_C = 2 \text{ mA},$ $f = 200 \text{ MHz},$ $f_{OSC} = 230 \text{ MHz (0dBm)}$
Oscillating output voltage	V_{OSC1}	—	300	—	mV	$V_{CC} = 12 \text{ V}, I_C = 7 \text{ mA},$ $f_{OSC} = 300 \text{ MHz}$
	V_{OSC2}	—	200	—	mV	$V_{CC} = 12 \text{ V}, I_C = 7 \text{ mA},$ $f_{OSC} = 930 \text{ MHz}$

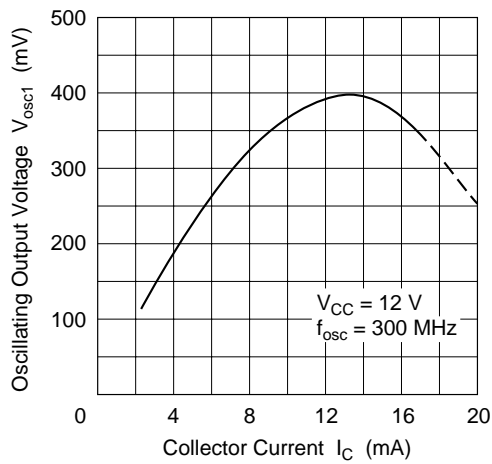




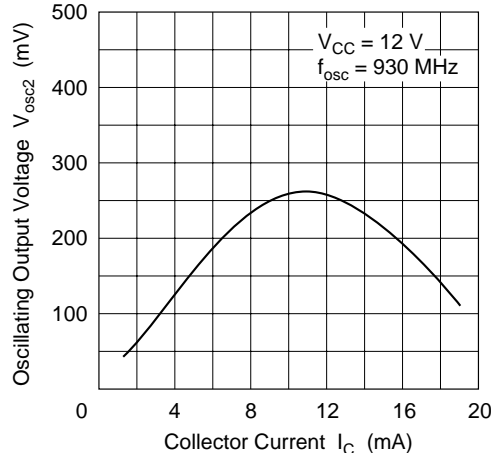
Conversion Gain vs.
Collector Current



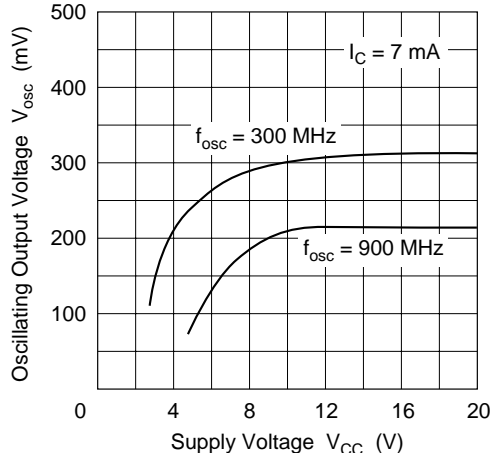
Oscillating Output Voltage vs.
Collector Current



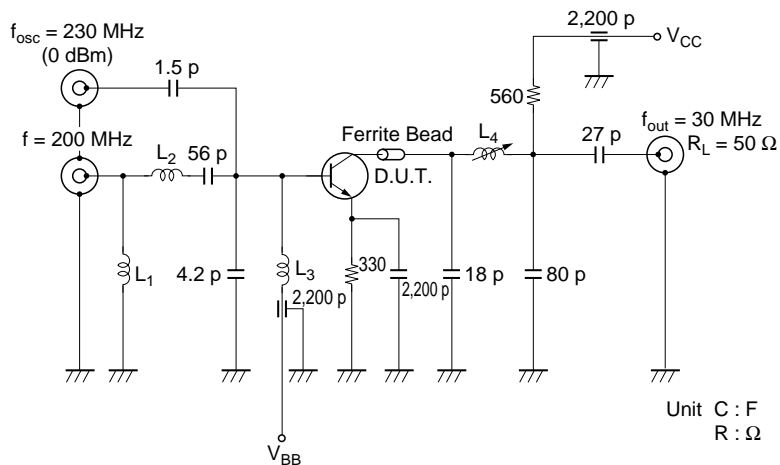
Oscillating Output Voltage vs.
Collector Current



Oscillating Output Voltage vs.
Supply Voltage



VHF Conversion Gain (CG_1) : Noise Figure Test Circuit

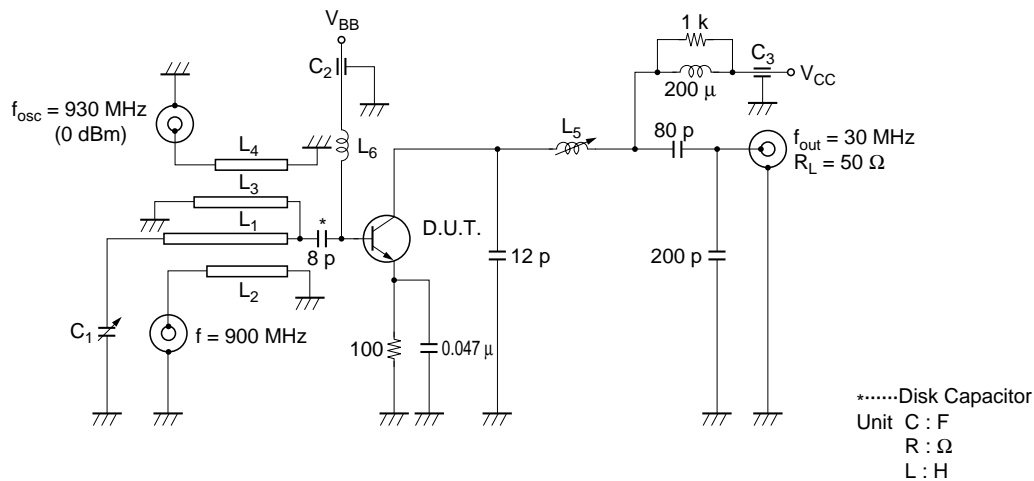


L_1 : $\phi 0.5 \text{ mm}$ Enameled Copper Wire
 4 Turns inside dia $\phi 5 \text{ mm}$

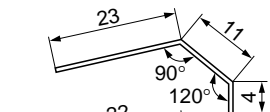
L_2 : $\phi 0.5 \text{ mm}$ Enameled Copper Wire
 4 Turns inside dia $\phi 4 \text{ mm}$

L_3 : $\phi 0.2 \text{ mm}$ Enameled Copper Wire
 6 Turns inside dia $\phi 3 \text{ mm}$

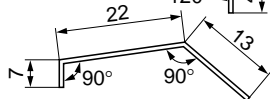
L_4 : Outside dia $\phi 5 \text{ mm}$ Bobbin,
 $\phi 0.2 \text{ mm}$ Enameled Copper Wire
 16 Turns Using Ferrite bead.

UHF Conversion Gain (CG_2) Test Circuit

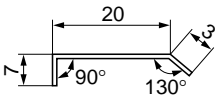
L_1 : $\phi 1$ mm Enameled
Copper Wire



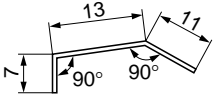
L_2 : $\phi 1$ mm Enameled
Copper Wire



L_3 : $\phi 1$ mm Enameled
Copper Wire



L_4 : $\phi 1$ mm Enameled
Copper Wire



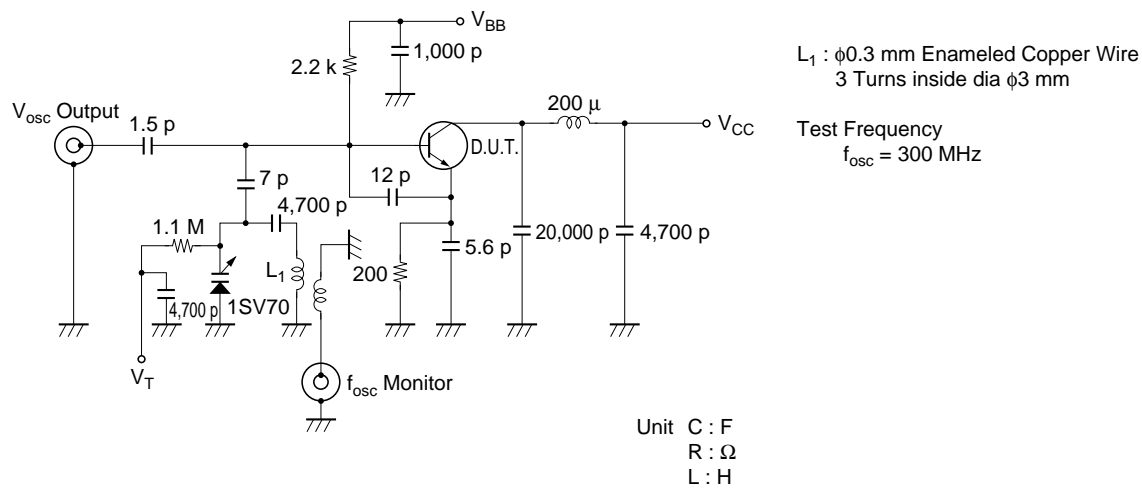
L_5 : Bobbin $\phi 5$ mm inside dia, $\phi 0.2$ mm Enameled Copper
Wire 20 Turns

L_6 : $\phi 0.5$ mm Enameled Copper Wire 1 Turn inside dia
 $\phi 6$ mm

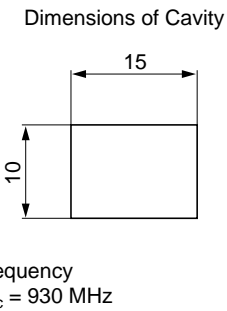
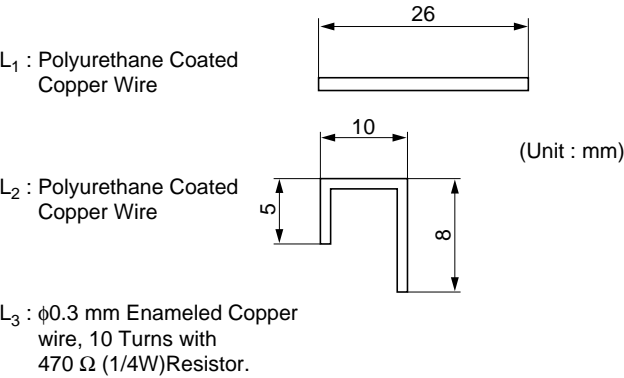
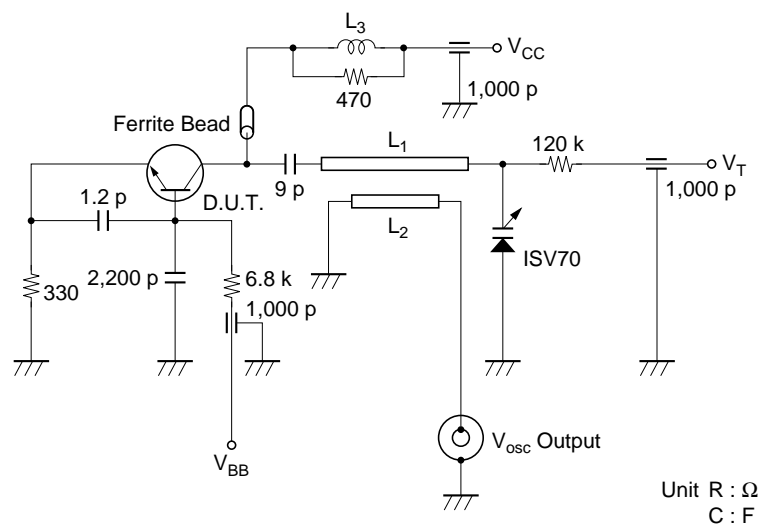
C_1 : 20 pF max Air Trimmer Condenser

C_2, C_3 : 1000 pF Air Core Capacitor

VHF Oscillating Output Voltage (V_{osc1}) Test Circuit

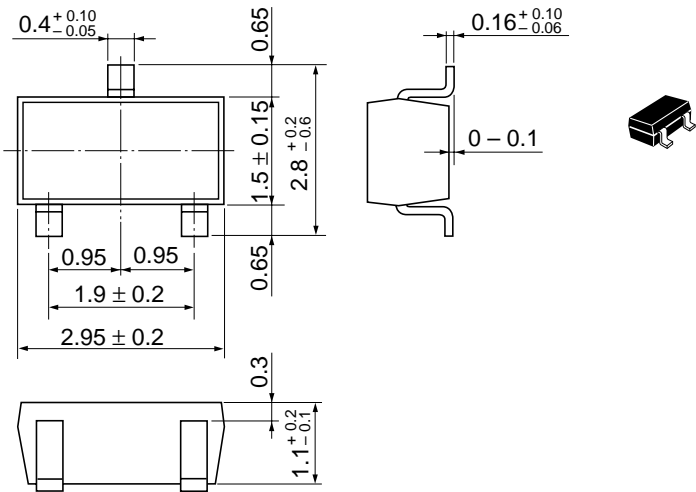


UHF Oscillating Output Voltage (V_{osc2}) Test Circuit



Package Dimensions

As of January, 2001
Unit: mm



Hitachi Code	MPAK
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.011 g

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